PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	577	STMicroelectronics International N.V
1.2 PCN No.		MDG/22/13076
1.3 Title of PCN		ST Muar (Malaysia) Additional capacity through High Density Matrix Leadframe for STM8A AUTOMOTIVE listed products in LQFP 64 10x10 package
1.4 Product Category		STM8AF52xx, STM8AF62xx, STM8AF63xx
1.5 Issue date		2022-09-07

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	ROBERTSON HEATHER	
2.1.2 Phone	+1 8475853058	
2.1.3 Email	heather.robertson@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Ricardo Antonio DE SA EARP	
2.1.2 Marketing Manager	Veronique BARLATIER	
2.1.3 Quality Manager	Pascal NARCHE	

3. Change			
3.1 Category	3.2 Type of change	3.3 Manufacturing Location	
Materials	New direct material part number r (same supplier, different supplier or new supplier),(Lead frame dimensions)	ST MUAR (Malaysia)	

4. Description of change			
	Old	New	
4.1 Description	The current Bill of Materials in ST Muar (Malaysia) assembly plant is described in Additional information document.	The New Bill of Materials in ST Muar (Malaysia) assembly plant with High Density Matrix Leadframe is described in Additional information document.	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	Form: Yes - marking change Fit: No change, Function: No change, No impact for customer		

5. Reason / motivation for change		
	The strategy of ST MCD Division is to increase the robustness and improve performances, quality and functionality of our products. This is achieved by introducing new Bill Of Material for STM8AF products.	
5.2 Customer Benefit	SERVICE CONTINUITY	

6. Marking of parts / traceability of change		
6.1 Description	Traceability ensured by ST internal tools	

7. Timing / schedule		
7.1 Date of qualification results	2022-12-30	
7.2 Intended start of delivery	2023-01-03	
7.3 Qualification sample available?	Not Applicable	

8. Qualification / Validation			
	13076 MDG-GPM-RER2214 PCN13076 ST Muar LQFP10x10 64L Automotive MTX to HD conversion - reliability plan.pdf		

8.2 Qualification report and qualification results		2022-09-07
qualification results	Date	

9. Attachments (additional documentations)

13076 Public product.pdf 13076 MDG-GPM-RER2214 PCN13076 ST Muar LQFP10x10 64L Automotive MTX to HD conversion - reliability plan.pdf 13076 PCN13076_Additional information.pdf

10. Affected parts			
10. 1 Current		10.2 New (if applicable)	
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No	
	STM8AF5269TAY		
	STM8AF5289TAY		
	STM8AF5289TCX		
	STM8AF5289TCY		
	STM8AF52A9TCY		
	STM8AF52A9TDY		
	STM8AF6269TAY		



Public Products List

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title: ST Muar (Malaysia) Additional capacity through High Density Matrix Leadframe for STM8A AUTOMOTIVE listed

products in LQFP 64 10x10 package **PCN Reference**: MDG/22/13076

Subject: Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STM8AF5269TAY	STM8AF6289TCX	STM8AF52A9TDY
STM8AF5289TCX	STM8AF6289TCY	STM8AF62A9TCY
STM8AF6269TCX	STM8AF52A9TCY	STM8AF6289TAY
STM8AF5269TAX	STM8AF62A9TDY	STM8AF6269TCY
STM8AF5289TCY	STM8AF6269TAY	STM8AF5289TAY
STM8AF52A9TCX	STM8AF52A9TAY	STM8AF62A9TCX

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